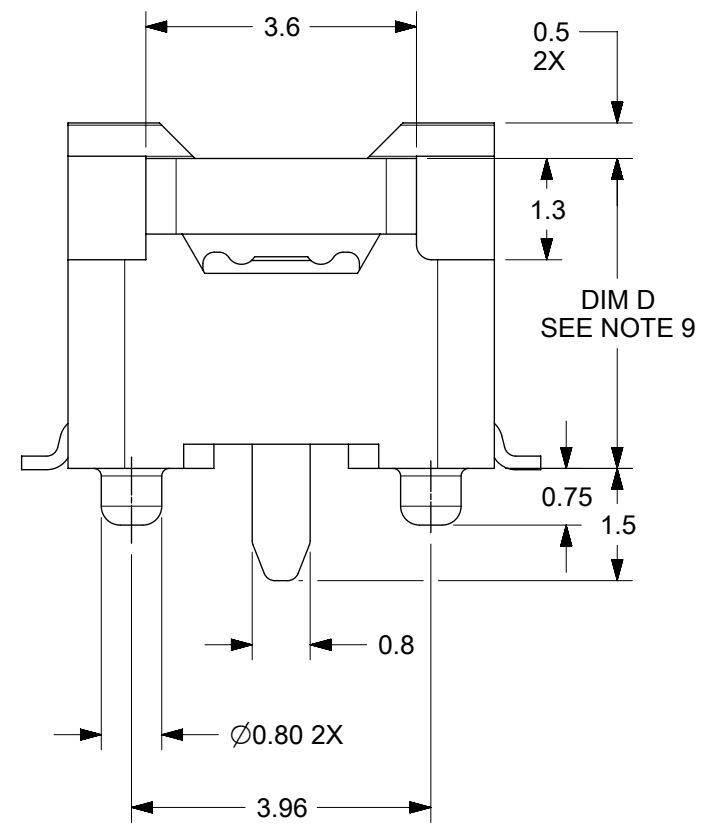
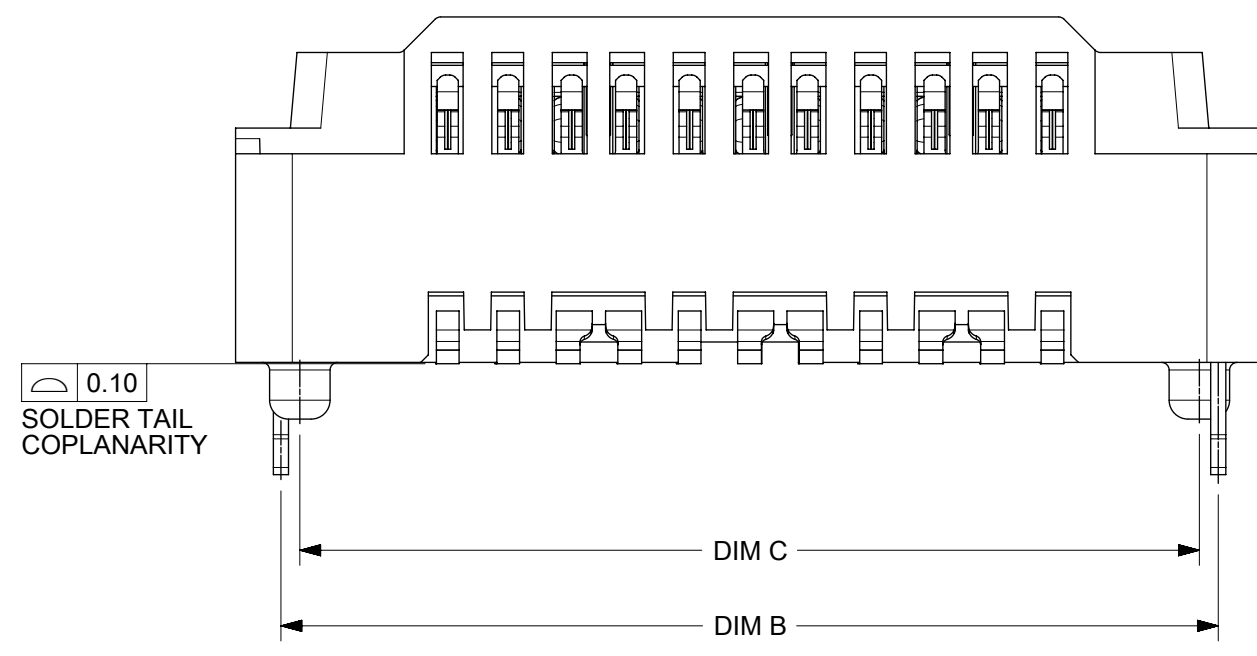
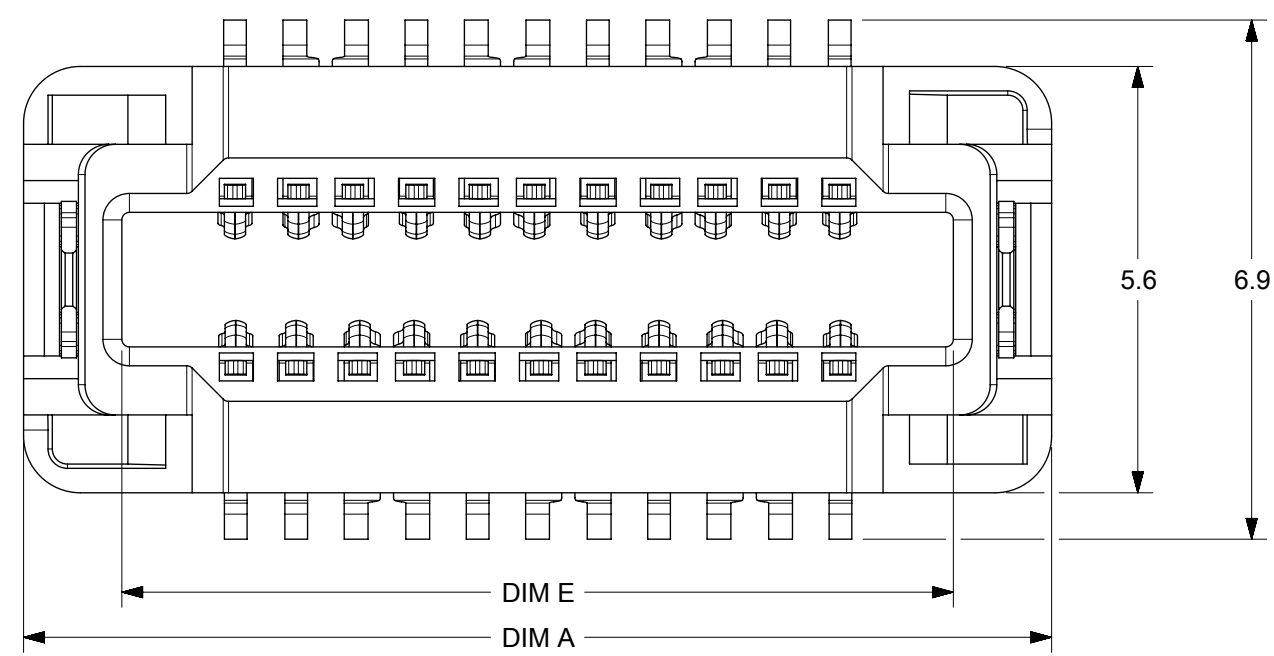


PART NUMBER	CKT SIZE	DIFF PAIRS	SPARE CKTS	DIM A	DIM B	DIM C	DIM E	DIM D
171450-5102	22	6	2	13.6	12.40	11.90	11.0	4.10
171450-5105	60	16	8	28.8	27.60	27.10	26.2	3.10
171450-5106								4.10
171450-5114	82	22	10	41.6	40.40	39.90	11.0/ 26.2	4.10



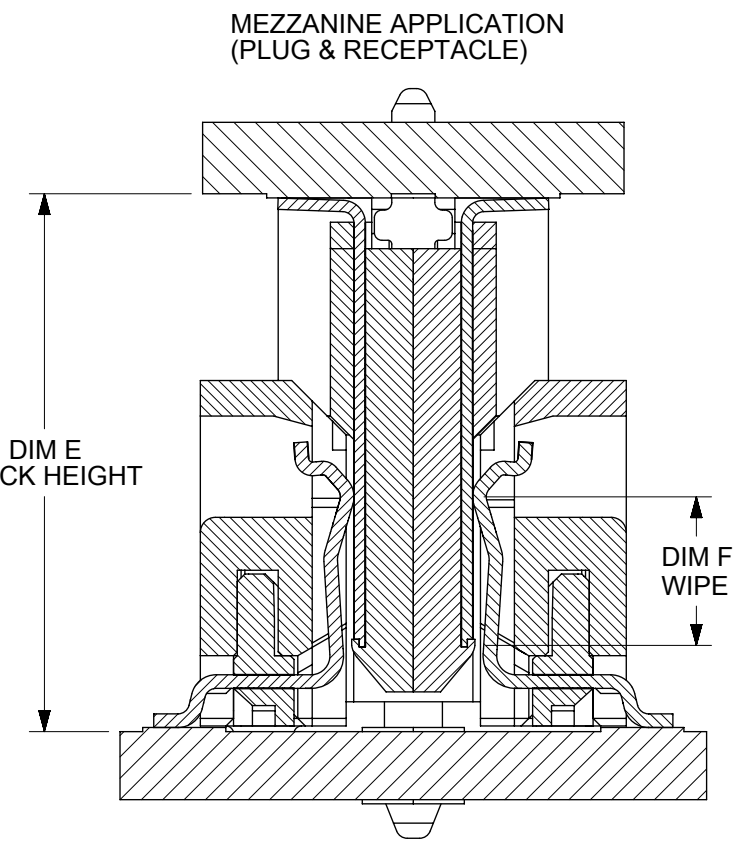
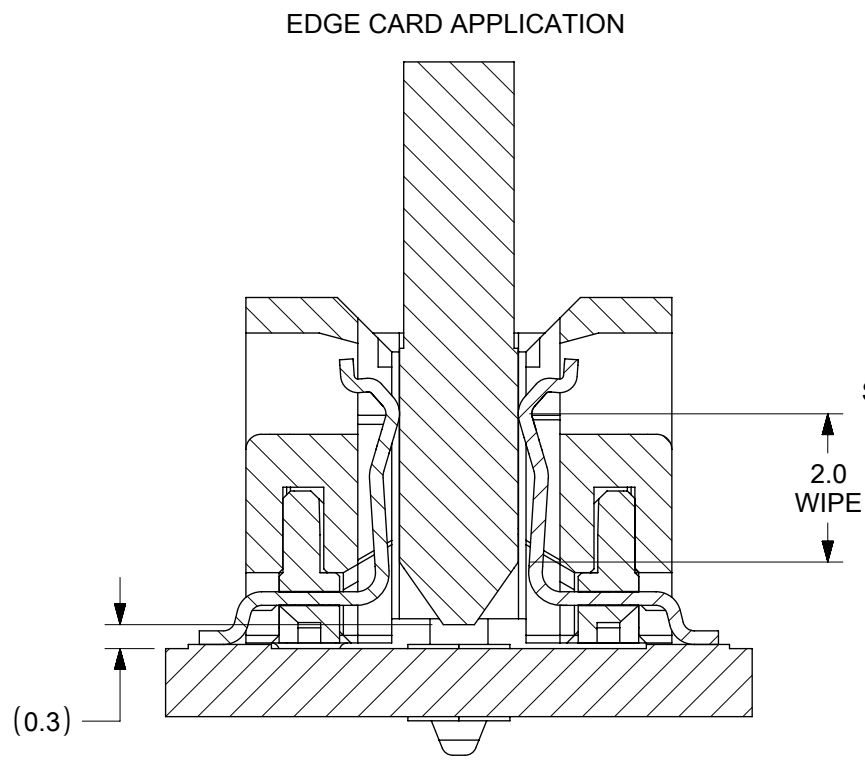
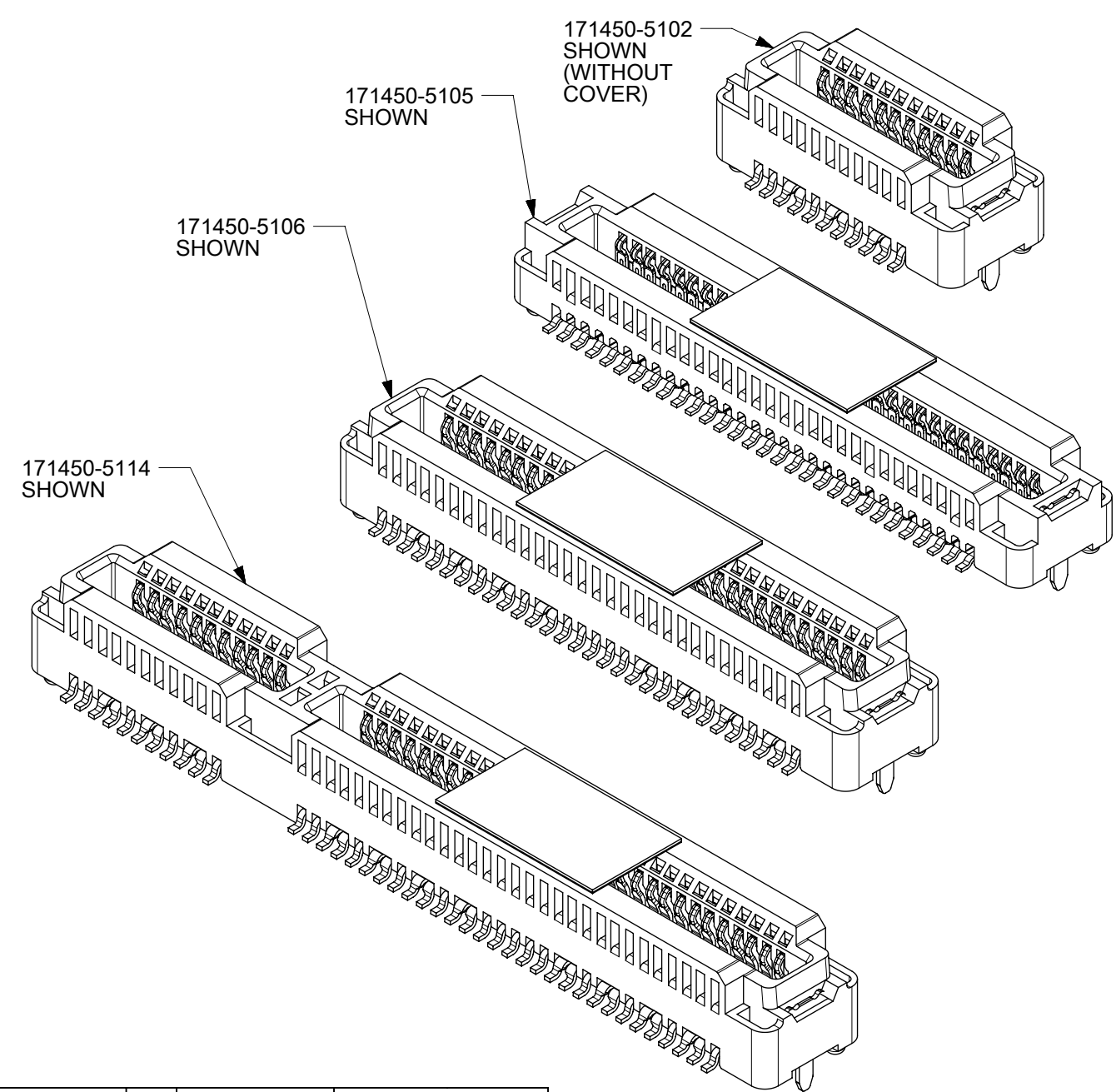
- NOTES:
1. MATERIALS: HOUSING: LCP, UL94V-0, BLACK  
CONTACTS: HIGH PERFORMANCE COPPER ALLOY
  2. FINISH: 0.76 μm MIN SELECT GOLD IN CONTACT AREA,  
SELECT MATTE TIN IN TAIL AREA, OVERALL NICKEL.
  3. PRODUCT SPECIFICATION: PS-171446-0001
  4. PACKAGING SPECIFICATION: PK-70873-6002
  5. MATES WITH SPEEDSTACK PLUGS: 171446 & 171810
  6. APPLICATION SPECIFICATION: AS-171450-9999
  7. COSMETIC SPECIFICATION: PS-45499-002 CLASS B
  8. PART STATUS: CONTACT MOLEX
  9. DIM D ON THIS DRAWING PLUS DIM D ON DRAWING # SD-171446-1000  
EQUALS THE SYSTEM MATED STACK HEIGHT
  10. PARTS SHIPPED WITH PICK AND PLACE COVERS.

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

DIMENSION UNITS <b>mm</b>	SCALE <b>10:1</b>	CURRENT REV DESC: ADD -5105		<b>molex</b>		
GENERAL TOLERANCES (UNLESS SPECIFIED)		EC NO: 623611				
ANGULAR TOL ± 0.5°	4 PLACES ±	DRWN: JBINGHAM	2019/09/03	PRODUCT CUSTOMER DRAWING		
3 PLACES ±	2 PLACES ± 0.13	CHK'D: KLANG	2019/09/06	DOCUMENT NUMBER		
1 PLACE ± 0.25	0 PLACES ±	APPR: KLANG	2019/09/06	SD-171450-5000		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	THIRD ANGLE PROJECTION	INITIAL REVISION:		DOC TYPE	DOC PART	REVISION
		DRWN: JBINGHAM	2016/08/25	PSD	001	B
		APPR: JBINGHAM	2016/09/07	MATERIAL NUMBER	CUSTOMER	SHEET NUMBER
		DRAWING	SERIES	SEE CHART	GENERAL MARKET	1 OF 8
		B-SIZE	171450			

# MEZZANINE (PLUG & RECEPTACLE) STACKING CHART

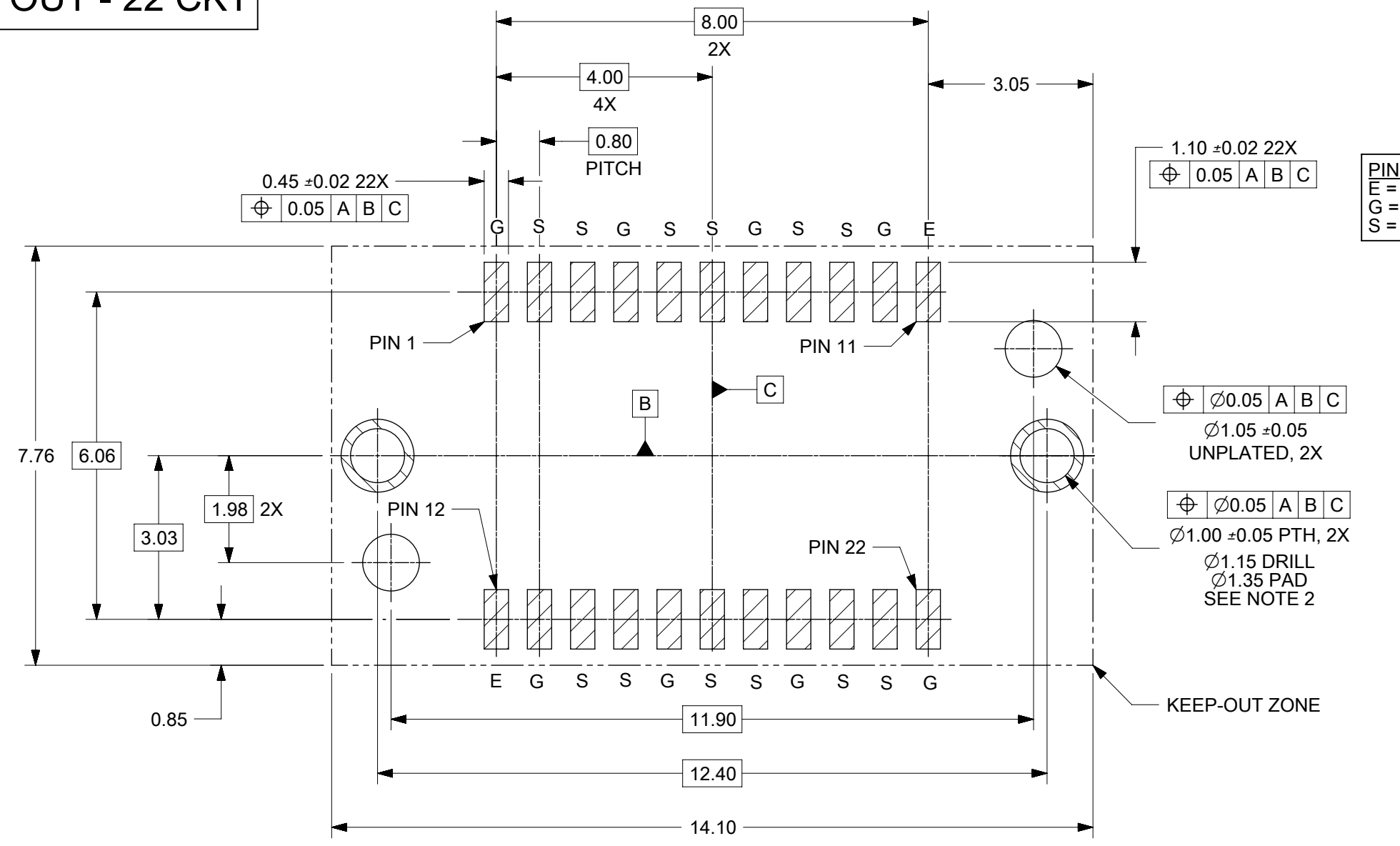
RECEPTACLE OPTIONS		PLUG OPTIONS (1mm WIPE)				PLUG OPTIONS (2mm WIPE)				
		HEIGHT	1mm	2mm	3mm	4mm	1mm	2mm	3mm	4mm
22 CKT	171446-1101	171446-1102	171446-1103	171446-1104	171446-1105	171446-1106	171446-1107	171446-1108		
60 CKT	171446-1109	171446-1110	171446-1111	171446-1112	171446-1113	171446-1114	171446-1115	171446-1116		
60 CKT	171450-5105	3mm	4/1	5/1	6/1	7/1	N/A			
22 CKT	171450-5102	4mm	5/1	6/1	7/1	8/1	5/2	6/2	7/2	8/2
60 CKT	171450-5106									
82 CKT	171450-5114									
CIRCUITS	MOLEX P/N	HEIGHT	STACK HEIGHT (DIM E)/WIPE (DIM F)							



THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

DIMENSION UNITS <b>mm</b>	SCALE <b>10:1</b>	CURRENT REV DESC: ADD -5105				
GENERAL TOLERANCES (UNLESS SPECIFIED)		EC NO: 623611	2019/09/03			
ANGULAR TOL ± 0.5°		DRWN: JBINGHAM	2019/09/06	PRODUCT CUSTOMER DRAWING		
4 PLACES ±		CHK'D: KLANG	2019/09/06	DOCUMENT NUMBER		
3 PLACES ±		APPR: KLANG	2019/09/06	SD-171450-5000		
2 PLACES ± 0.13		INITIAL REVISION:		DOC TYPE	DOC PART	REVISION
1 PLACE ± 0.25		DRWN: JBINGHAM	2016/08/25	PSD	001	B
0 PLACES ±		APPR: JBINGHAM	2016/09/07	SHEET NUMBER		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	THIRD ANGLE PROJECTION	DRAWING	SERIES	MATERIAL NUMBER	CUSTOMER	
		B-SIZE	171450	SEE CHART	GENERAL MARKET	2 OF 8

# PCB LAYOUT - 22 CKT



**PINOUT LEGEND**  
 E = EXTRA  
 G = GROUND  
 S = SIGNAL

⊕ 0.05 A B C  
 ∅1.05 ±0.05  
 UNPLATED, 2X

⊕ 0.05 A B C  
 ∅1.00 ±0.05 PTH, 2X  
 ∅1.15 DRILL  
 ∅1.35 PAD  
 SEE NOTE 2

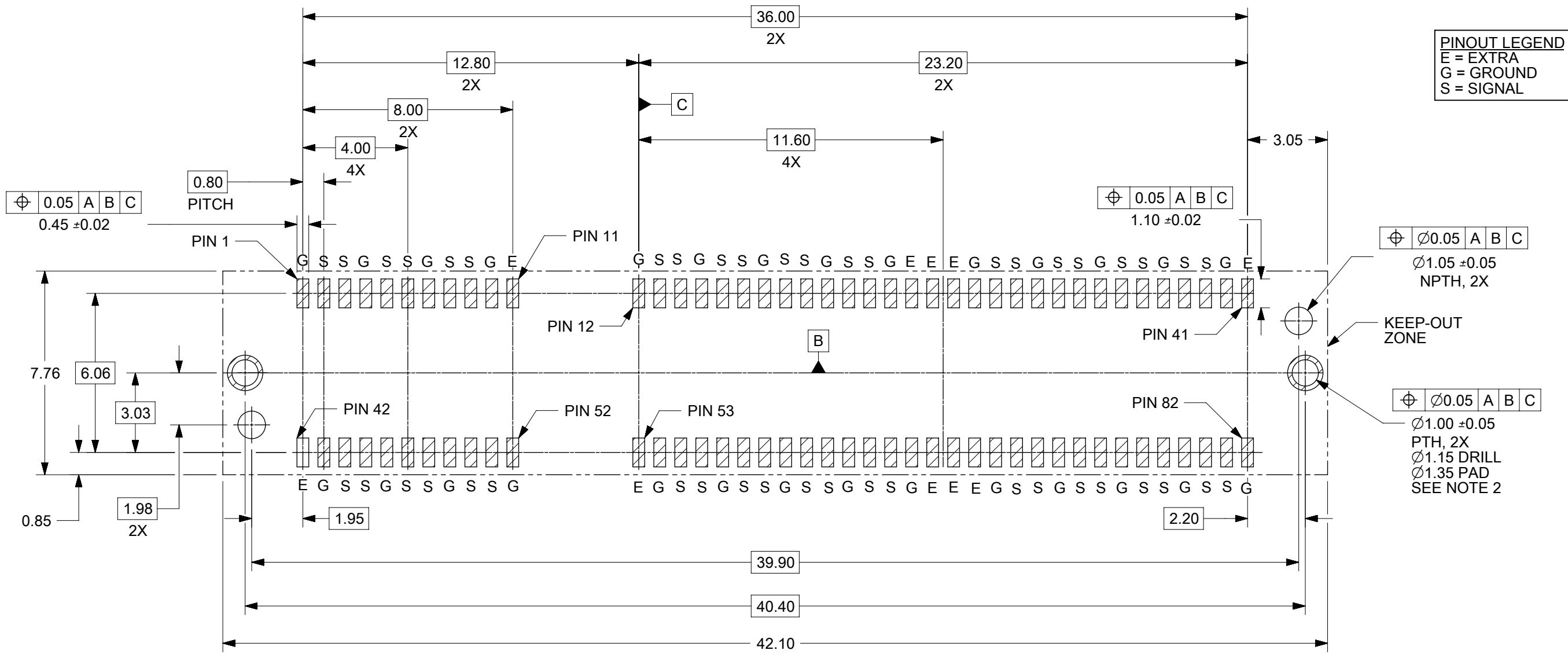
PCB LAYOUT (COMPONENT SIDE)  
 SOLDER PASTE THICKNESS: 0.15 MIN  
 DATUM **A** IS THE BOTTOM SURFACE OF THE PCB

- NOTES:**
- PIN NUMBERING IS FOR REFERENCE ONLY. OTHER PIN NUMBERS WILL NOT AFFECT THE OPERATION OF THE CONNECTOR.
  - RETENTION NAIL MUST BE SOLDERED ONTO THE PCB FOR PROPER CONNECTOR FUNCTION.

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									
DIMENSION UNITS	SCALE	CURRENT REV DESC: ADD -5105							
mm	10:1								
GENERAL TOLERANCES (UNLESS SPECIFIED)									
ANGULAR TOL	± 0.5°	EC NO: 623611 DRWN: JBINGHAM 2019/09/03 CHK'D: KLANG 2019/09/06 APPR: KLANG 2019/09/06							
4 PLACES	±	<b>PRODUCT CUSTOMER DRAWING</b>							
3 PLACES	±								
2 PLACES	± 0.13	<b>INITIAL REVISION:</b> DRWN: JBINGHAM 2016/08/25 APPR: JBINGHAM 2016/09/07							
1 PLACE	± 0.25	DOCUMENT NUMBER		DOC TYPE	DOC PART	REVISION	SD-171450-5000 PSD 001 B		
0 PLACES	±	MATERIAL NUMBER		CUSTOMER		SHEET NUMBER			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION	DRAWING	SERIES	SEE CHART	GENERAL MARKET	3 OF 8		



# PCB LAYOUT - 82 CKT



PCB LAYOUT (COMPONENT SIDE)  
 SOLDER PASTE THICKNESS: 0.15 MIN  
 DATUM **A** IS THE BOTTOM SURFACE OF THE PCB

- NOTES:**
- PIN NUMBERING IS FOR REFERENCE ONLY. OTHER PIN NUMBERS WILL NOT AFFECT THE OPERATION OF THE CONNECTOR.
  - RETENTION NAIL MUST BE SOLDERED ONTO THE PCB FOR PROPER CONNECTOR FUNCTION.

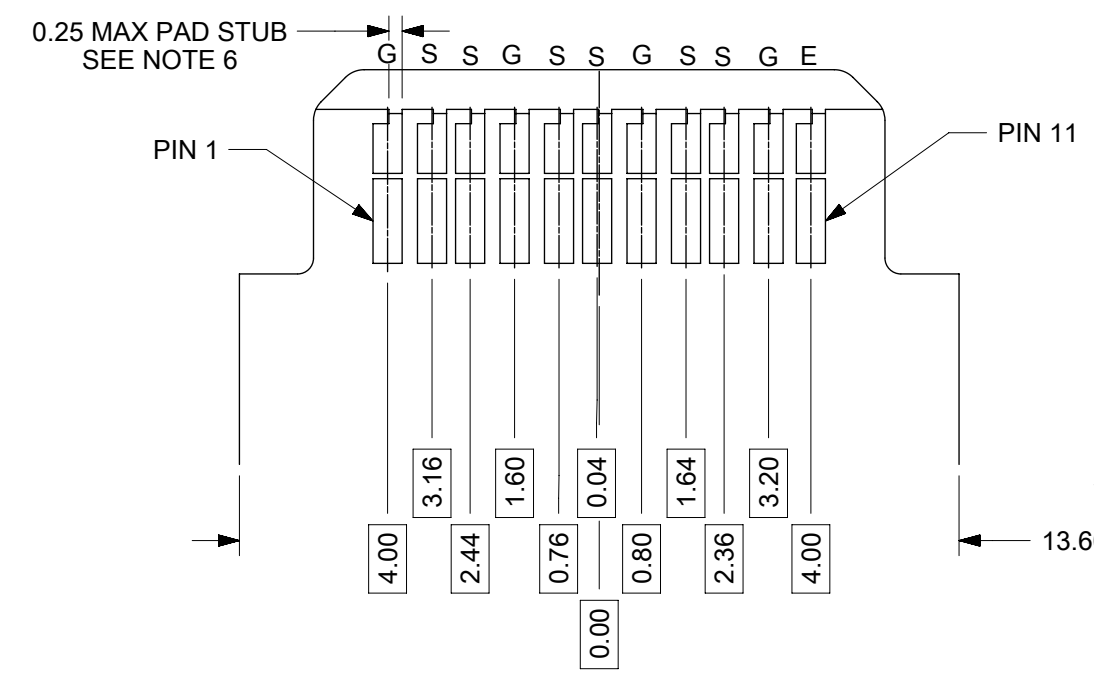
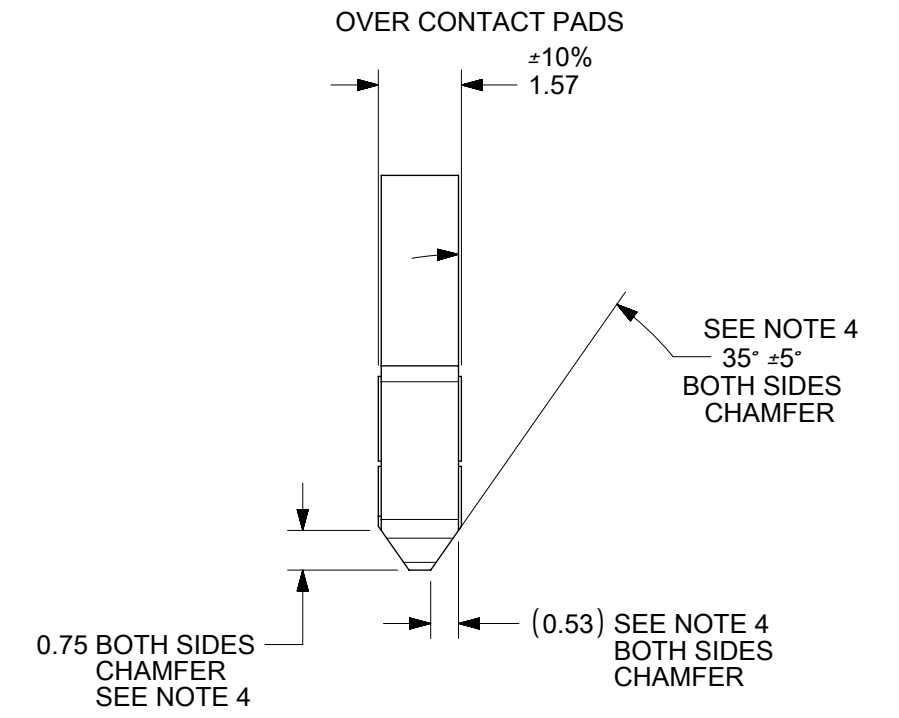
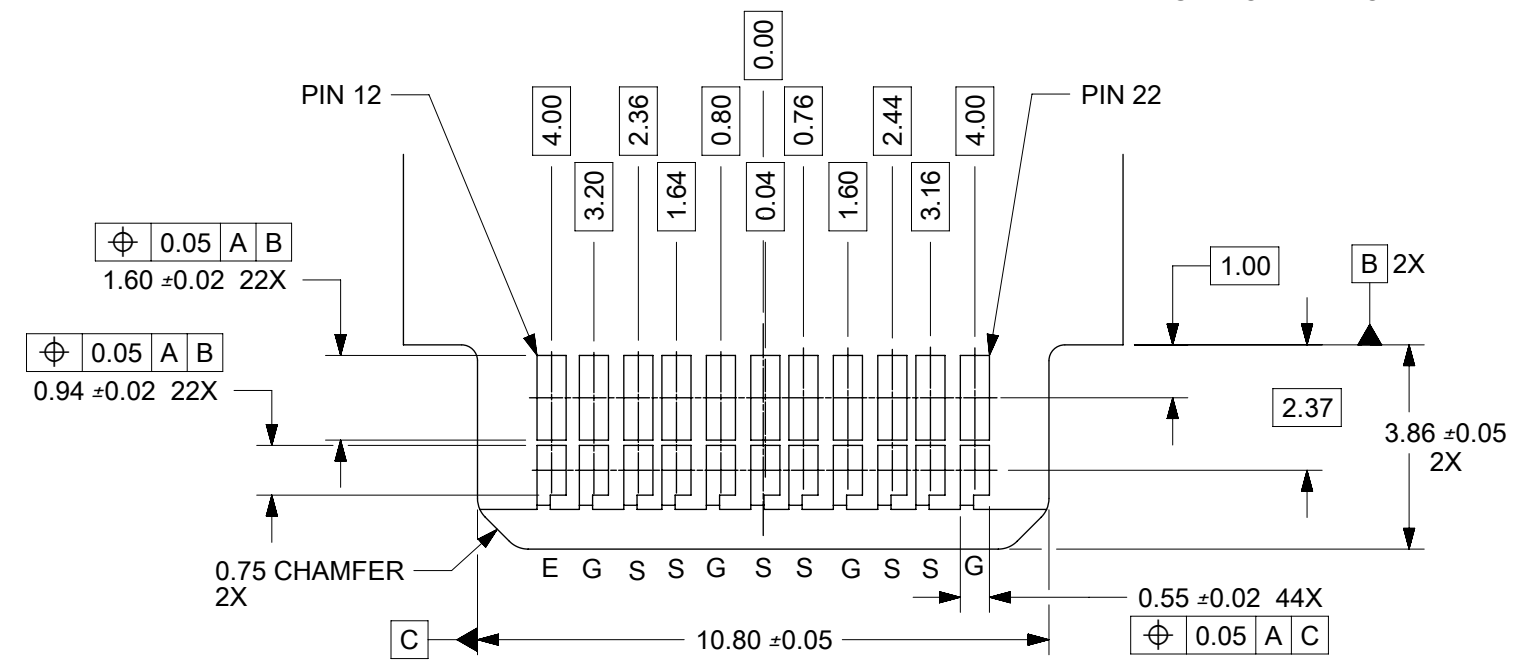
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION												
DIMENSION UNITS <b>mm</b>		SCALE <b>6:1</b>		CURRENT REV DESC: ADD -5105						<b>molex</b>		
GENERAL TOLERANCES (UNLESS SPECIFIED)				EC NO: 623611								
ANGULAR TOL ± 0.5°				DRWN: JBINGHAM		2019/09/03		SPEEDSTACK RECEPTACLE ASSEMBLY SALES DRAWING				
4 PLACES ±				CHK'D: KLANG		2019/09/06		PRODUCT CUSTOMER DRAWING				
3 PLACES ±				APPR: KLANG		2019/09/06		DOCUMENT NUMBER				
2 PLACES ± 0.13				INITIAL REVISION:				SD-171450-5000		DOC TYPE	DOC PART	REVISION
1 PLACE ± 0.25				DRWN: JBINGHAM		2016/08/25		PSD	001	B		
0 PLACES ±				APPR: JBINGHAM		2016/09/07						
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION		DRAWING		SERIES		MATERIAL NUMBER		CUSTOMER		SHEET NUMBER
		B-SIZE		171450		SEE CHART		GENERAL MARKET		5 OF 8		

DOCUMENT STATUS	P1	RELEASE DATE	2019/09/06	02:51:33
-----------------	----	--------------	------------	----------

# EDGECARD LAYOUT - 22 CKT

## FRONT SIDE

DATUM **A** IS THE OPPOSITE SIDE OF THE PCB



## BACK SIDE

DATUM **A** IS THE OPPOSITE SIDE OF THE PCB

**PINOUT LEGEND**  
 E = EXTRA  
 G = GROUND  
 S = SIGNAL

- NOTES:**
- PIN NUMBERING IS FOR REFERENCE ONLY. OTHER PIN NUMBERS WILL NOT AFFECT THE OPERATION OF THE CONNECTOR.
  - EDGE CARD SHOULDERS STOP ON RECEPTACLE SHOULDERS. EDGE CARD BOTTOM DOES NOT CONTACT RECEPTACLE PCB.
  - PAD SET BACK FROM CHAMFER ENOUGH TO ACCOMMODATE LARGEST CHAMFER WITHOUT DAMAGE TO PAD EDGE.
  - CHAMFER DEPTH SHOULD BE AS LARGE AS PRACTICAL TO ENSURE CORRECT MATING TO THE RECEPTACLE.
  - ALL CHAMFERED EDGES SHOULD BE ROUNDED WHERE POSSIBLE.
  - INTERNAL PLATING BRIDGES ARE PREFERRED TO ELIMINATE PAD STUB.

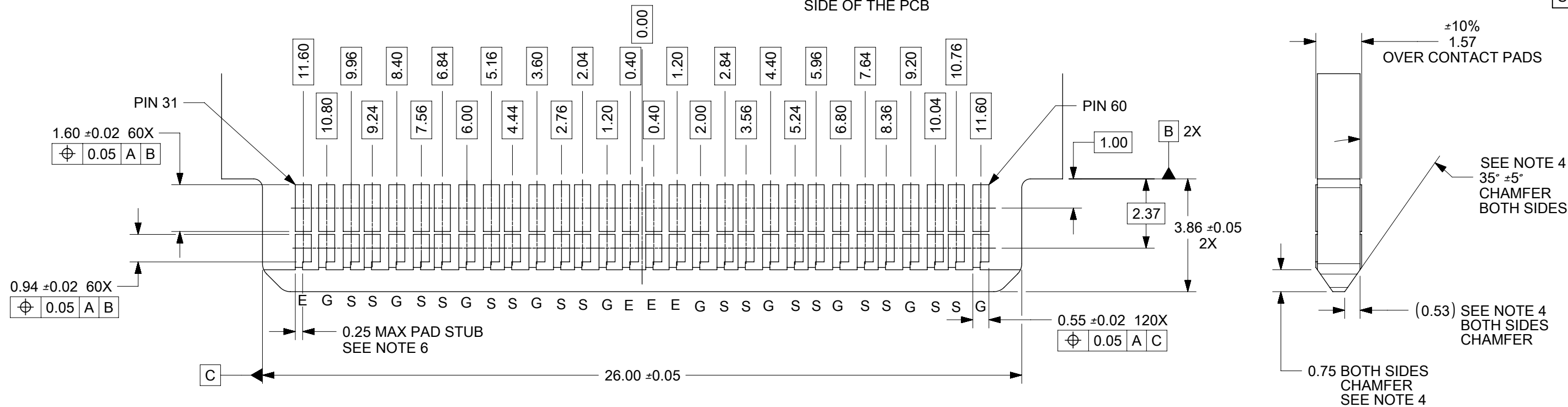
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									
DIMENSION UNITS		SCALE		CURRENT REV DESC: ADD -5105					
mm		7:1		<b>molex</b> SPEEDSTACK RECEPTACLE ASSEMBLY SALES DRAWING PRODUCT CUSTOMER DRAWING					
GENERAL TOLERANCES (UNLESS SPECIFIED)									
ANGULAR TOL ± 0.5°									
4 PLACES ±									
3 PLACES ±									
2 PLACES ± 0.13				EC NO: 623611		2019/09/03		DOCUMENT NUMBER	
1 PLACE ± 0.25				DRWN: JBINGHAM		2019/09/06		SD-171450-5000	
0 PLACES ±				APPR: KLANG		2019/09/07		PSD 001 B	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION		DRAWING		SERIES		MATERIAL NUMBER	
		B-SIZE		171450		SEE CHART		GENERAL MARKET	
								SHEET NUMBER	
								6 OF 8	

# EDGECARD LAYOUT - 60 CKT

## FRONT SIDE

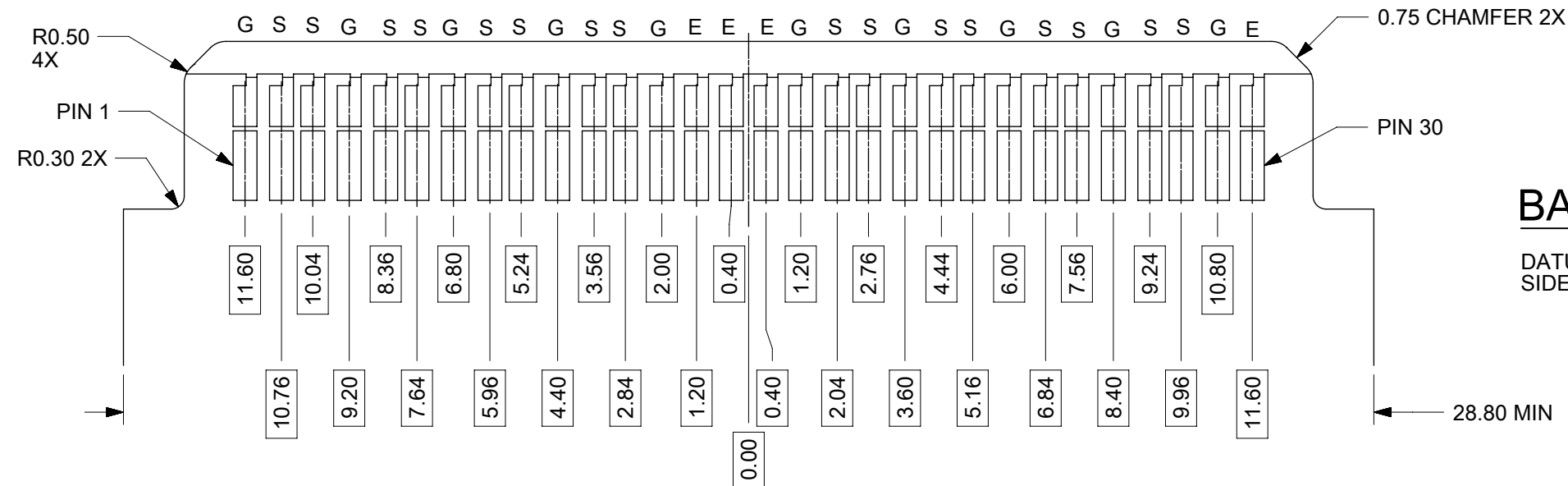
DATUM **A** IS THE OPPOSITE SIDE OF THE PCB

**PINOUT LEGEND**  
 E = EXTRA  
 G = GROUND  
 S = SIGNAL



## BACK SIDE

DATUM **A** IS THE OPPOSITE SIDE OF THE PCB



### NOTES:

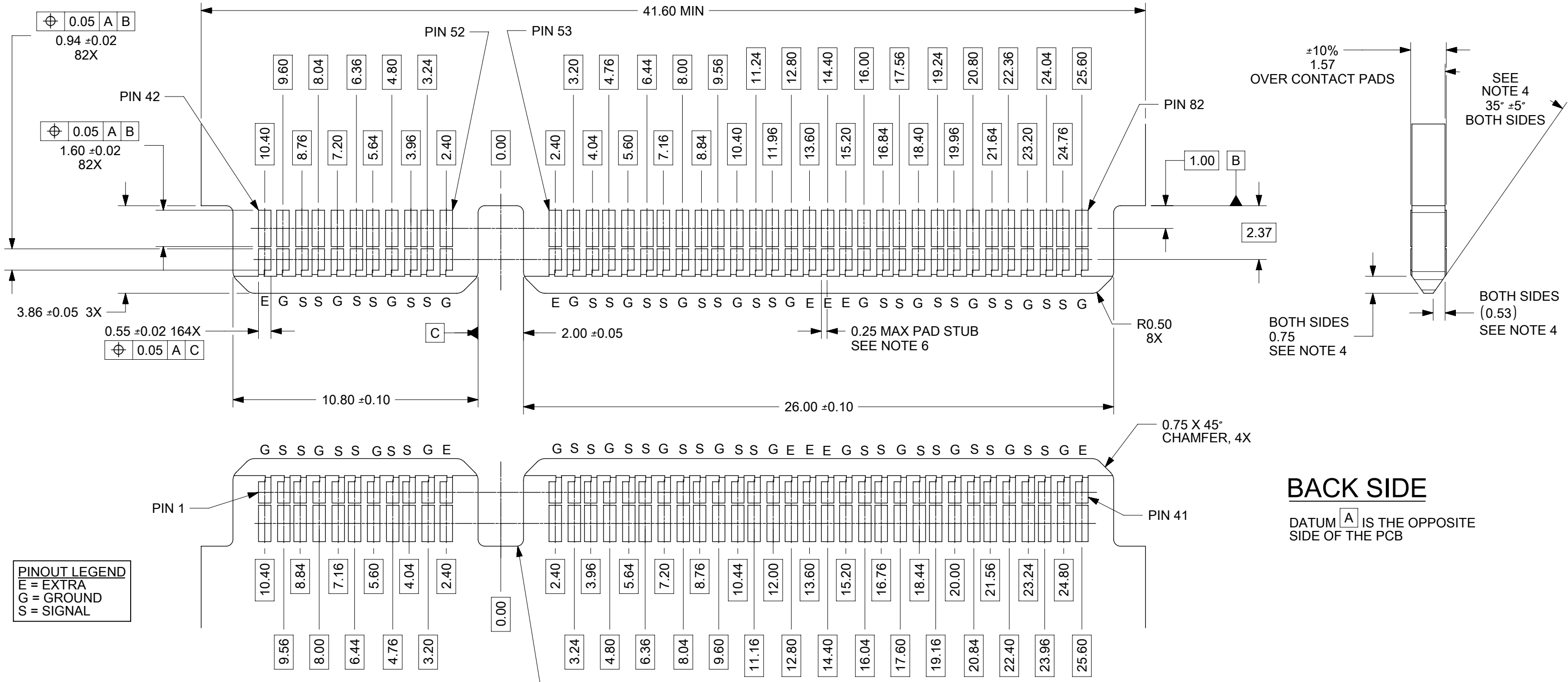
- PIN NUMBERING IS FOR REFERENCE ONLY. OTHER PIN NUMBERS WILL NOT AFFECT THE OPERATION OF THE CONNECTOR.
- EDGE CARD SHOULDERS STOP ON RECEPTACLE SHOULDERS. EDGE CARD BOTTOM DOES NOT CONTACT RECEPTACLE PCB.
- PAD SET BACK FROM CHAMFER ENOUGH TO ACCOMMODATE LARGEST CHAMFER WITHOUT DAMAGE TO PAD EDGE.
- CHAMFER DEPTH SHOULD BE AS LARGE AS PRACTICAL TO ENSURE CORRECT MATING TO THE RECEPTACLE.
- ALL CHAMFERED EDGES SHOULD BE ROUNDED WHERE POSSIBLE.
- INTERNAL PLATING BRIDGES ARE PREFERRED TO ELIMINATE PAD STUB.

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																			
DIMENSION UNITS	SCALE	CURRENT REV DESC: ADD -5105																	
mm	7:1	<table border="1"> <tr> <td colspan="2"><b>molex</b></td> </tr> <tr> <td colspan="2">SPEEDSTACK RECEPTACLE ASSEMBLY SALES DRAWING</td> </tr> <tr> <td colspan="2">PRODUCT CUSTOMER DRAWING</td> </tr> <tr> <td>DOCUMENT NUMBER</td> <td>DOC TYPE   DOC PART   REVISION</td> </tr> <tr> <td>SD-171450-5000</td> <td>PSD   001   B</td> </tr> </table>								<b>molex</b>		SPEEDSTACK RECEPTACLE ASSEMBLY SALES DRAWING		PRODUCT CUSTOMER DRAWING		DOCUMENT NUMBER	DOC TYPE   DOC PART   REVISION	SD-171450-5000	PSD   001   B
<b>molex</b>																			
SPEEDSTACK RECEPTACLE ASSEMBLY SALES DRAWING																			
PRODUCT CUSTOMER DRAWING																			
DOCUMENT NUMBER	DOC TYPE   DOC PART   REVISION																		
SD-171450-5000	PSD   001   B																		
GENERAL TOLERANCES (UNLESS SPECIFIED)																			
ANGULAR TOL ± 0.5°																			
4 PLACES ±																			
3 PLACES ±																			
2 PLACES ± 0.13																			
1 PLACE ± 0.25																			
0 PLACES ±																			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	THIRD ANGLE PROJECTION	DRAWING	SERIES	MATERIAL NUMBER	CUSTOMER	SHEET NUMBER													
		B-SIZE	171450	SEE CHART	GENERAL MARKET	7 OF 8													

# FRONT SIDE

# EDGECARD LAYOUT - 82 CKT

DATUM **A** IS THE OPPOSITE SIDE OF THE PCB



**PINOUT LEGEND**  
 E = EXTRA  
 G = GROUND  
 S = SIGNAL

# BACK SIDE

DATUM **A** IS THE OPPOSITE SIDE OF THE PCB

- NOTES:**
- PIN NUMBERING IS FOR REFERENCE ONLY. OTHER PIN NUMBERS WILL NOT AFFECT THE OPERATION OF THE CONNECTOR.
  - EDGE CARD SHOULDERS STOP ON RECEPTACLE SHOULDERS. EDGE CARD BOTTOM DOES NOT CONTACT RECEPTACLE PCB.
  - PAD SET BACK FROM CHAMFER ENOUGH TO ACCOMMODATE LARGEST CHAMFER WITHOUT DAMAGE TO PAD EDGE.
  - CHAMFER DEPTH SHOULD BE AS LARGE AS PRACTICAL TO ENSURE CORRECT MATING TO THE RECEPTACLE.
  - ALL CHAMFERED EDGES SHOULD BE ROUNDED WHERE POSSIBLE.
  - INTERNAL PLATING BRIDGES ARE PREFERRED TO ELIMINATE PAD STUB.

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									
DIMENSION UNITS: mm		SCALE: 6:1		CURRENT REV DESC: ADD -5105					
GENERAL TOLERANCES (UNLESS SPECIFIED)				<b>molex</b> SPEEDSTACK RECEPTACLE ASSEMBLY SALES DRAWING PRODUCT CUSTOMER DRAWING					
ANGULAR TOL ± 0.5°									
4 PLACES ±									
3 PLACES ±									
2 PLACES ± 0.13									
1 PLACE ± 0.25				EC NO: 623611		2019/09/03		DRWN: JBINGHAM	
0 PLACES ±				CHK'D: KLANG		2019/09/06		APPR: KLANG	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				THIRD ANGLE PROJECTION		DRAWING: B-SIZE		SERIES: 171450	
DOCUMENT STATUS: P1		RELEASE DATE: 2019/09/06 02:51:33		INITIAL REVISION:		2016/08/25		DOCUMENT NUMBER: SD-171450-5000	
				DRWN: JBINGHAM		2016/09/07		DOC TYPE: PSD	
				APPR: JBINGHAM				DOC PART: 001	
								REVISION: B	
				MATERIAL NUMBER: SEE CHART		CUSTOMER: GENERAL MARKET		SHEET NUMBER: 8 OF 8	